

### **Description**

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

#### **Features**

- $30V,120A,R_{DS(on).max}=3.1m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- ♦ 100% EAS Guaranteed
- Green device available

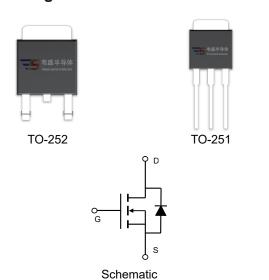
### **Applications**

- Motor Drives
- UPS
- DC-DC Converter

# **Product Summary**

 $\begin{array}{ll} V_{DSS} & 30V \\ R_{DS(on).max} @\ V_{GS} {=} 10V & 3.1 m\Omega \\ I_D & 120A \end{array}$ 

## **Pin Configuration**



# Absolute Maximum Ratings Tc = 25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	30	V
Continuous drain current ( T <sub>C</sub> = 25°C ) <sup>1)</sup>		120	A
Continuous drain current ( Tc = 100°C )¹)	I <sub>D</sub>	82	A
Pulsed drain current <sup>2)</sup>	Ірм	480	A
Gate-Source voltage	V <sub>GSS</sub>	±20	V
Avalanche energy <sup>3)</sup>	Eas	470	mJ
Power Dissipation ( T <sub>C</sub> = 25°C )	P <sub>D</sub>	130	W
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C
Operating Junction Temperature Range	TJ	-55 to +150	°C

### **Thermal Characteristics**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	Rejc	0.96	°C/W
Thermal Resistance, Junction-to-Ambient	Reja	68	°C/W



**Package Marking and Ordering Information** 

Device	Device Package	Marking
VSM120N03-T2	TO-252	VSM120N03-T2
VSM120N03-T1	TO-251	VSM120N03-T1

## **Electrical Characteristics** T<sub>J</sub> = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static characteristics					•	
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0 V, I <sub>D</sub> =250uA	30			V
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	1.1		2.1	V
Drain-source leakage current	I <sub>DSS</sub>	V <sub>DS</sub> =30 V, V <sub>GS</sub> =0 V, T <sub>J</sub> = 25°C			1	μA
		V <sub>DS</sub> =30 V, V <sub>GS</sub> =0 V, T <sub>J</sub> = 125°C			5	μA
Gate leakage current, Forward	I <sub>GSSF</sub>	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V			100	nA
Gate leakage current, Reverse	I <sub>GSSR</sub>	V <sub>GS</sub> =-20 V, V <sub>DS</sub> =0 V			-100	nA
Drain course en etate registance	В	V <sub>GS</sub> =10 V, I <sub>D</sub> =30 A		1.8	3.1	mΩ
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5 V, I <sub>D</sub> =15 A		2.4	4.5	mΩ
Forward transconductance	g <sub>fs</sub>	V <sub>DS</sub> =5 V , I <sub>D</sub> =50A	26			S
Dynamic characteristics						
Input capacitance	Ciss	N 00 V V 0 V		8430		pF
Output capacitance	Coss	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V},$ F = 1 MHz		930		
Reverse transfer capacitance	Crss	7 F = 11VIDZ		879		
Turn-on delay time	t <sub>d(on)</sub>			15		ns
Rise time	t <sub>r</sub>	V <sub>DD</sub> = 30V,V <sub>GS</sub> =10V, I <sub>D</sub> =20 A		17		
Turn-off delay time	t <sub>d(off)</sub>			52		
Fall time	tf			23		
Gate resistance	Rg	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, F=1MHz		1.67		Ω
Gate charge characteristics						
Gate to source charge	Q <sub>gs</sub>	V 00 V 1 00 A		23		
Gate to drain charge	Q <sub>gd</sub>	V <sub>DS</sub> =20 V, I <sub>D</sub> =20A, V <sub>GS</sub> =10 V		25		nC
Gate charge total	Qg			146		
Drain-Source diode characteris	tics and Maxi	mum Ratings				
Continuous Source Current	Is				120	А
Pulsed Source Current <sup>4)</sup>	I <sub>SM</sub>				480	А
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =50A, T <sub>J</sub> =25℃			1.2	V
Reverse Recovery Time	t <sub>rr</sub>			117		ns
Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>S</sub> =20A, di/dt=60A/us, T <sub>J</sub> =25℃		30		nC

### Notes:

- 1: The maximum junction current rating is package limited.
- 2: Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3:  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =97A,  $R_G$ =25 $\Omega$ , Starting  $T_J$ =25 $^{\circ}$ C.
- 4: Pulse Test: Pulse Width  $\leq 300~\mu$  s, Duty Cycle  $\leq 2\%$  .



### **Electrical Characteristics Diagrams**

Figure 1. Typ. Output Characteristics

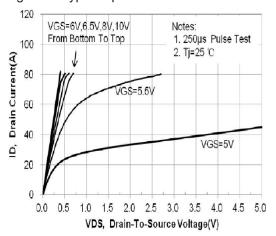


Figure 3. Capacitance Characteristics

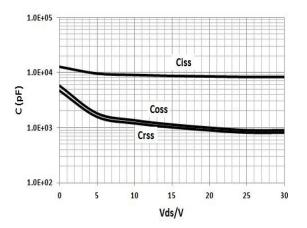


Figure 5. Body-Diode Characteristics

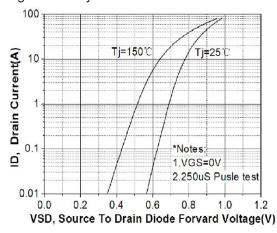


Figure 2. Transfer Characteristics

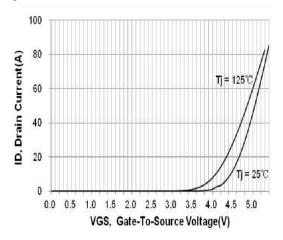


Figure 4. Gate Charge Waveform

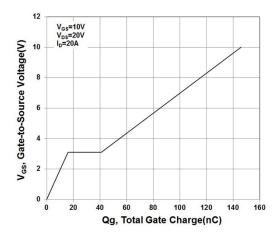


Figure 6.Maximum Safe Operating Area

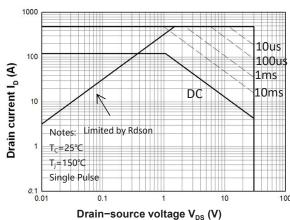




Figure 6. Normalized Maximum Transient Thermal Impedance (RthJC)

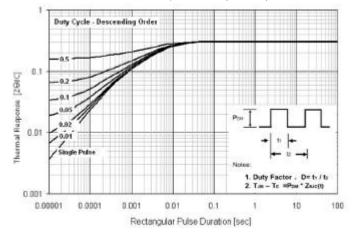
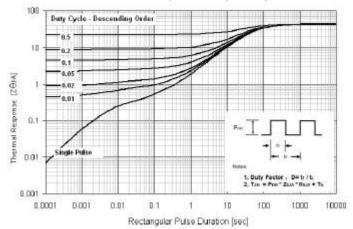


Figure 7. Normalized Maximum Transient Thermal Impedance (RthJA)

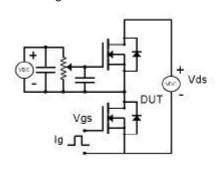


v1.2 Page 4 http://www.vseei.com/



## **Test Circuit & Waveform**

Figure 8. Gate Charge Test Circuit & Waveform



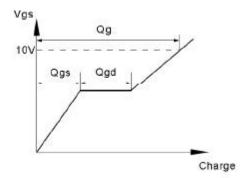
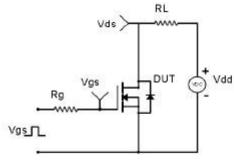


Figure 9. Resistive Switching Test Circuit & Waveforms



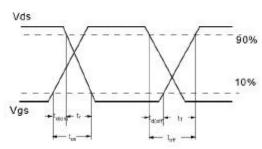
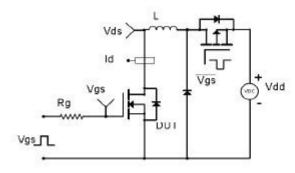


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit & Waveform



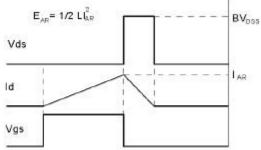


Figure 11. Diode Recovery Circuit & Waveform

